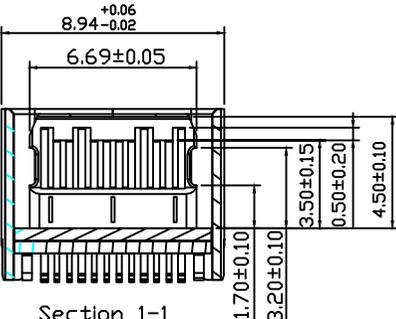
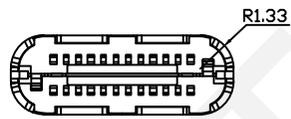


Section A-A

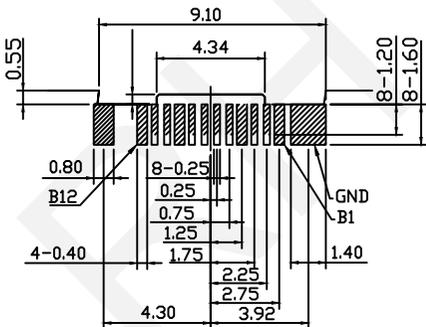
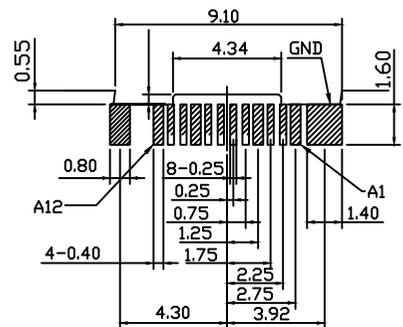
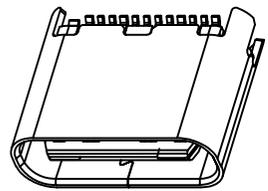


Section 1-1



PIN	Signal Name	PIN	Signal Name
A1	GND	B12	GND
A2	SSTXP1	B11	SSRXP1
A3	SSTXN1	B10	SSRXN1
A4	VBUS	B9	VBUS
A5	CC1	B8	SBU2
A6	DP1	B7	DN2
A7	DN1	B6	DP2
A8	SBU1	B5	CC2
A9	VBUS	B4	VBUS
A10	SSRXN2	B3	SSTXN2
A11	SSRXP2	B2	SSTXP2
A12	GND	B1	GND

Material:
Molding:LCP UL94V-0
Contact:Copper Alloy.
Gold Plated Min 0n Contact Area.
100u*Min Tin (Lead Free) On Solder Area
Shell:SUS304-H,T=0.30±0.03mm
50u*Nickel Plating Over All.
Shield:SUS304-H,T=0.12±0.03mm
Mechanical:
Insertion:5~20N
Extraction:8~20N After Test
Durability:10000 Cycles
3.Electrical:
Current:5A For VBUS
1.25A For GND Pin.
0.25A For Other.
Voltage:20 V Max
Withstanding Voltage:100V AC R.M.S
Contact Resistance:40mΩ Max
Insulation Resistance:100Ω Min
4.Environmental:
Temperature Range -25°C~+85°C



RECOMMENDED PCB LAYOUT T=0.80mm
TOLERANCE:±0.05mm

RHTECP NINGBO RHT ELECTRONIC CO.,LTD

UNITS:mm	SHEET SIZE: A4	SCALE:---	DRWN BY PAN
0~3	3~18	18~50	50~120
±0.12	±0.15	±0.3	±0.5

CHK'D BY FENG
APPR BY ZHAN

CF Splint
THIRD ANGLE PROJECTION
 RHTAY469